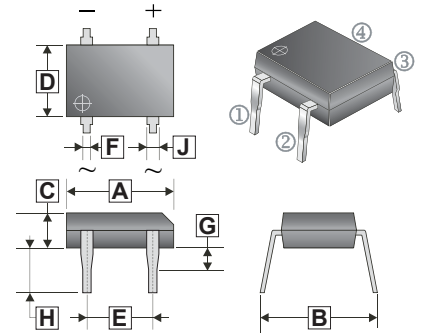


RoHS Compliant Product
 A suffix of "-C" specifies halogen & lead-free

FEATURES

- Low forward voltage drop, high current capability
- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique results in inexpensive products
- Lead tin Pb / Sn copper
- The plastic material has UL flammability classification 94V-0

DB-1



PACKAGING INFORMATION

- Polarity: As marked on Body
- Weight: 0.38 grams (approximately)
- Mounting position: Any

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	8.20	8.80	F	0.45	0.55
B	7.60	8.90	G	1.50 (TYP.)	
C	3.15	3.40	H	3.90	4.90
D	6.20	6.50	J	-	-
E	5.00	5.20			

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating at 25°C ambient temperature unless otherwise specified.
 Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, de-rate current by 20%.

PARAMETERS	SYMBOL	DB	DB	DB	DB	DB	DB	DB	UNIT
		1501	1502	1503	1504	1505	1506	1507	
Peak Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V_{RMS}	35	70	140	280	420	560	700	
DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	
Maximum Average Forward Rectified Current @ $T_A=40^\circ C$	$I_{(AV)}$	1.5							A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC Method)	I_{FSM}	50							A
Maximum Forward Voltage at 1.5 A DC	V_F	1.1							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	I_R	10 500							uA
I^2t Rating for Fusing (t<8.3ms)	I^2t	10.4							A ² s
Typical Junction Capacitance Per Element (Note1)	C_J	25							pF
Typical Thermal Resistance (Note2)	$R_{\theta JA}$	40							°C/W
Operating and Storage temperature range	T_J, T_{STG}	-55 ~ 150							°C

Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC
 2. Thermal resistance from junction to ambient mounted on P.C.B. with 0.5*0.5"(13*13mm) copper pads.

RATINGS AND CHARACTERISTIC CURVES

FIG. 1 - Forward Current Derating Curve

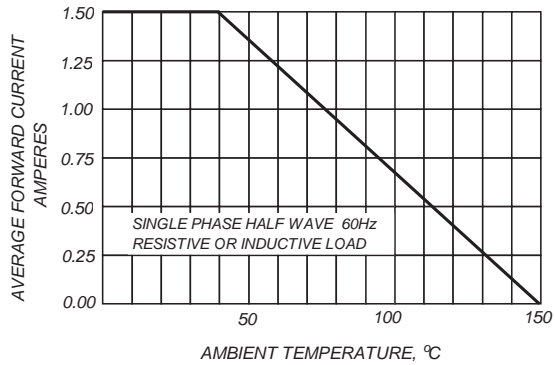


FIG.2-MAXIMUM NON-REPETITIVE SURGE CURRENT

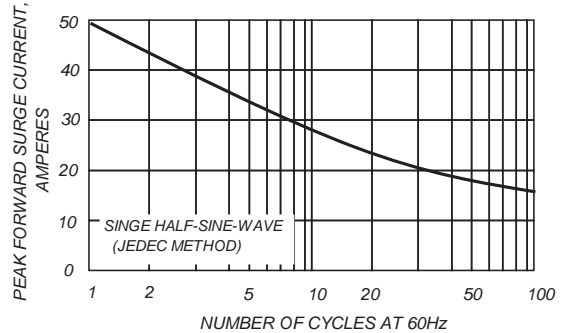


FIG.3-TYPICAL JUNCTION CAPACITANCE

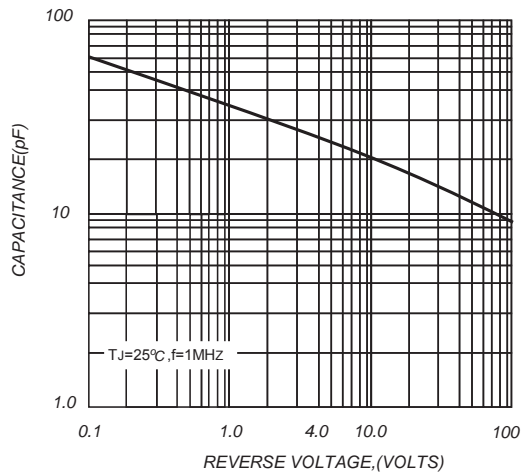


FIG.4-TYPICAL FORWARD CHARACTERISTICS

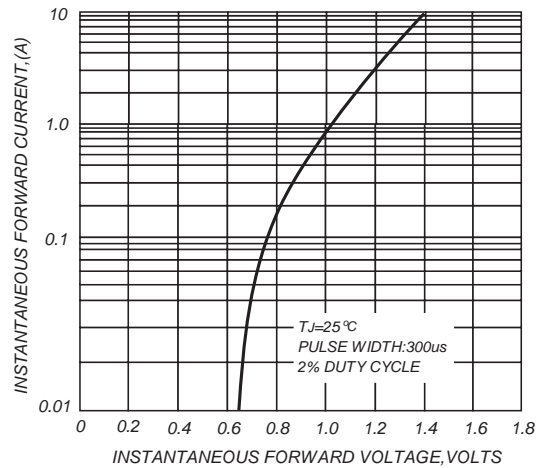


FIG.5-TYPICAL REVERSE CHARACTERISTICS

